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Details

Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	SCI, SPI
Peripherals	LVD, POR, PWM
Number of I/O	33
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 8x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-QFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc908gp32cfbe

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1.3 MCU Block Diagram

Figure 1-1 shows the structure of the MC68HC908GP32. Text in parentheses within a module block indicates the module name. Text in parentheses next to a signal indicates the module which uses the signal.



† Ports are software configurable with pullup device if input port.

‡ Higher current drive port pins

* Pin contains integrated pullup device



Pin Assignments





Pins Not Available on 42-Pin Package	Internal Connection		
PTC5	Connected to ground		
PTC6	Connected to ground		

Figure 1-3. 42-Pin SDIP Pin Assignments



Input/Output (I/O) Section

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$003A	PLL VCO Range Select Register	Read: Write:	VRS7	VRS6	VRS5	VRS4	VRS3	VRS2	VRS1	VRS0
	(PMRS)	Reset:	0	1	0	0	0	0	0	0
	PLL Reference Divider	Read:	0	0	0	0	0002	0002	DDS1	PDG0
\$003B	Select Register	Write:					TID00	TID 02	nbor	HD00
	(PMDS)	Reset:	0	0	0	0	0	0	0	1
	Analog-to-Digital Status and	Read:	0000		ADCO	ADCH4	ADCH3	ADCH2	ADCH1	ADCH0
\$003C	Control Register	Write:	R	/	1.000		7.00110		//Boilli	7.BOTTO
	(ADSCR)	Reset:	0	0	0	1	1	1	1	1
	Analog-to-Digital Data	Read:	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
\$003D	Register	Write:								
	(ADR)	Reset:	0	0	0	0	0	0	0	0
\$003E	Analog-to-Digital Clock Register	Read: Write:	ADIV2	ADIV1	ADIV0	ADICLK	0	0	0	0
	(ADCLK)	Reset:	0	0	0	0	0	0	0	0
		Read:								
\$003F	Unimplemented	Write:								
	·	Reset:								
		Read:	_	_	_	_	_		SBSW	
\$FE00	SIM Break Status Register	Write:	К	К	К	К	К	К	Note	К
	(SBSR)	Reset:							0	
	Note: Writing a logic 0 clears	SBSW.								
		Read:	POR	PIN	COP	ILOP	ILAD	MODRST	LVI	0
\$FE01	SIM Reset Status Register	Write:	-			-				-
, .	(SRSR)	POR:	1	0	0	0	0	0	0	0
	SIM Linner Byte Address	Read:	_	_		_	_		_	_
\$FE02	Register	Write:	R	R	R	R	R	R	R	R
	(SUBAR)	Reset:								
	SIM Break Flag Control	Read:		_	_	_	_	_	_	_
\$FE03	Register	Write:	BCFE	R	К	R	R	К	R	К
	(SBFCR)	Reset:	0							
		Read:	IF6	IF5	IF4	IF3	IF2	IF1	0	0
\$FE04	Interrupt Status Register 1	Write:	R	R	R	R	R	R	R	R
	(INTT)	Reset:	0	0	0	0	0	0	0	0
		Read:	IF14	IF13	IF12	IF11	IF10	IF9	IF8	IF7
\$FE05	Interrupt Status Register 2	Write:	R	R	R	R	R	R	R	R
	(IN 12)	Reset:	0	0	0	0	0	0	0	0
		Read:	0	0	0	0	0	0	IF16	IF15
\$FE06	Interrupt Status Register 3	Write:	R	R	R	R	R	R	R	R
	(IN 13)	Reset:	0	0	0	0	0	0	0	0
		Read:	-	_	5	_	-		-	_
\$FE07	Reserved	Write:	К	К	К	Н	К		К	К
		Reset:	0	0	0	0	0	0	0	0
				= Unimplem	nented	R = Reserve	d	U = Una	affected	

Figure 2-2. Control, Status, and Data Registers (Sheet 5 of 6)



ADCO — ADC Continuous Conversion Bit

When set, the ADC will convert samples continuously and update the ADR register at the end of each conversion. Only one conversion is completed between writes to the ADSCR when this bit is cleared. Reset clears the ADCO bit.

1 = Continuous ADC conversion

0 = One ADC conversion

ADCH4–ADCH0 — ADC Channel Select Bits

ADCH4–ADCH0 form a 5-bit field which is used to select one of 16 ADC channels. Only eight channels, AD7–AD0, are available on this MCU. The channels are detailed in Table 4-1. Care should be taken when using a port pin as both an analog and digital input simultaneously to prevent switching noise from corrupting the analog signal. (See Table 4-1.)

The ADC subsystem is turned off when the channel select bits are all set to 1. This feature allows for reduced power consumption for the MCU when the ADC is not being used.

NOTE

Recovery from the disabled state requires one conversion cycle to stabilize.

The voltage levels supplied from internal reference nodes, as specified in Table 4-1, are used to verify the operation of the ADC converter both in production test and for user applications.

ADCH4	ADCH3	ADCH2	ADCH1	ADCH0	Input Select
0	0	0	0	0	PTB0/AD0
0	0	0	0	1	PTB1/AD1
0	0	0	1	0	PTB2/AD2
0	0	0	1	1	PTB3/AD3
0	0	1	0	0	PTB4/AD4
0	0	1	0	1	PTB5/AD5
0	0	1	1	0	PTB6/AD6
0	0	1	1	1	PTB7/AD7
0	1	0	0	0	
\downarrow	\downarrow	\downarrow	\downarrow	\downarrow	Reserved
1	1	1	0	0	
1	1	1	0	1	V _{REFH}
1	1	1	1	0	V _{REFL}
1	1	1	1	1	ADC power off

Table 4-1. Mux Channel Select

NOTE: If any unused channels are selected, the resulting ADC conversion will be unknown or reserved.





ADICLK — ADC Input Clock Select Bit

ADICLK selects either the bus clock or CGMXCLK as the input clock source to generate the internal ADC clock. Reset selects CGMXCLK as the ADC clock source.

If the external clock (CGMXCLK) is equal to or greater than 1 MHz, CGMXCLK can be used as the clock source for the ADC. If CGMXCLK is less than 1 MHz, use the PLL-generated bus clock as the clock source. As long as the internal ADC clock is at approximately 1 MHz, correct operation can be guaranteed.

1 = Internal bus clock

0 = External clock (CGMXCLK)

 $\frac{ADC \text{ input clock frequency}}{ADIV2 - ADIV0} = 1 MHz$



Chapter 7 Computer Operating Properly (COP)

7.1 Introduction

The computer operating properly (COP) module contains a free-running counter that generates a reset if allowed to overflow. The COP module helps software recover from runaway code. Prevent a COP reset by clearing the COP counter periodically. The COP module can be disabled through the COPD bit in the CONFIG register.

7.2 Functional Description

Figure 7-1 shows the structure of the COP module.



Figure 7-1. COP Block Diagram



Keyboard Interrupt (KBI) Module

10.8 I/O Signals

The KBI module can share its pins with the general-purpose I/O pins.

10.8.1 KBI Input Pins (KBI7:KBI0)

Each KBI pin is independently programmable as an external interrupt source. Each KBI pin when enabled will automatically configure a pullup device.

10.9 Registers

The following registers control and monitor operation of the KBI module:

- INTKBSCR (keyboard interrupt status and control register)
- INTKBIER (keyboard interrupt enable register)

10.9.1 Keyboard Status and Control Register (INTKBSCR)

Features of the INTKBSCR:

- Flags keyboard interrupt requests
- Acknowledges keyboard interrupt requests
- Masks keyboard interrupt requests
- Controls keyboard interrupt triggering sensitivity

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	0	0	0	0	KEYF	0	IMAGKK	MODEK
Write:						ACKK	IWASKK	
Reset:	0	0	0	0	0	0	0	0
		= Unimplemented						

Figure 10-2. Keyboard Status and Control Register (INTKBSCR)

Bits 7–4 — Not used

KEYF — Keyboard Flag Bit

This read-only bit is set when a keyboard interrupt is pending.

- 1 = Keyboard interrupt pending
- 0 = No keyboard interrupt pending

ACKK — Keyboard Acknowledge Bit

Writing a 1 to this write-only bit clears the KBI request. ACKK always reads 0.

IMASKK— Keyboard Interrupt Mask Bit

Writing a 1 to this read/write bit prevents the output of the KBI latch from generating interrupt requests.

- 1 = Keyboard interrupt requests disabled
- 0 = Keyboard interrupt requests enabled

MODEK — Keyboard Triggering Sensitivity Bit

This read/write bit controls the triggering sensitivity of the keyboard interrupt pins.

- 1 = Keyboard interrupt requests on falling edges and low levels
- 0 = Keyboard interrupt requests on falling edges only



Input/Output (I/O) Ports

Figure 12-15 shows the port D I/O logic.

NOTE

For those devices packaged in a 40-pin dual in-line package, PTD6 and PTD7 are not connected. DDRD6 and DDRD7 should be set to a 1 to configure PTD6 and PTD7 as outputs.



Figure 12-15. Port D I/O Circuit

When bit DDRDx is a logic 1, reading address \$0003 reads the PTDx data latch. When bit DDRDx is a logic 0, reading address \$0003 reads the voltage level on the pin. The data latch can always be written, regardless of the state of its data direction bit. Table 12-5 summarizes the operation of the port D pins.

Table 12-5.	Port D Pin	Functions
-------------	------------	-----------

			I/O Bin Mode	Accesses to DDRD	Accesses to PTD	
FIDFOLDIC		FIDDI	NO FIL MODE	Read/Write	Read	Write
1	0	X ⁽¹⁾	Input, V _{DD} ⁽⁴⁾	DDRD7-DDRD0	Pin	PTD7–PTD0 ⁽³⁾
0	0	Х	Input, Hi-Z ⁽²⁾	DDRD7-DDRD0	Pin	PTD7–PTD0 ⁽³⁾
Х	1	Х	Output	DDRD7-DDRD0	PTD7-PTD0	PTD7–PTD0

Notes:

1. X = Don't care

2. Hi-Z = High impedance

Writing affects data register, but does not affect input.
I/O pin pulled up to V_{DD} by internal pullup device.





If the TE bit is cleared during a transmission, the PTE0/TxD pin becomes idle after completion of the transmission in progress. Clearing and then setting the TE bit during a transmission queues an idle character to be sent after the character currently being transmitted.

NOTE

When queueing an idle character, return the TE bit to logic 1 before the stop bit of the current character shifts out to the TxD pin. Setting TE after the stop bit appears on TxD causes data previously written to the SCDR to be lost.

Toggle the TE bit for a queued idle character when the SCTE bit becomes set and just before writing the next byte to the SCDR.

13.4.2.5 Inversion of Transmitted Output

The transmit inversion bit (TXINV) in SCI control register 1 (SCC1) reverses the polarity of transmitted data. All transmitted values, including idle, break, start, and stop bits, are inverted when TXINV is at logic 1. (See 13.8.1 SCI Control Register 1.)

13.4.2.6 Transmitter Interrupts

These conditions can generate CPU interrupt requests from the SCI transmitter:

- SCI transmitter empty (SCTE) The SCTE bit in SCS1 indicates that the SCDR has transferred a character to the transmit shift register. SCTE can generate a transmitter CPU interrupt request. Setting the SCI transmit interrupt enable bit, SCTIE, in SCC2 enables the SCTE bit to generate transmitter CPU interrupt requests.
- Transmission complete (TC) The TC bit in SCS1 indicates that the transmit shift register and the SCDR are empty and that no break or idle character has been generated. The transmission complete interrupt enable bit, TCIE, in SCC2 enables the TC bit to generate transmitter CPU interrupt requests.

13.4.3 Receiver

Figure 13-5 shows the structure of the SCI receiver.

13.4.3.1 Character Length

The receiver can accommodate either 8-bit or 9-bit data. The state of the M bit in SCI control register 1 (SCC1) determines character length. When receiving 9-bit data, bit R8 in SCI control register 2 (SCC2) is the ninth bit (bit 8). When receiving 8-bit data, bit R8 is a copy of the eighth bit (bit 7).

13.4.3.2 Character Reception

During an SCI reception, the receive shift register shifts characters in from the PTE1/RxD pin. The SCI data register (SCDR) is the read-only buffer between the internal data bus and the receive shift register.

After a complete character shifts into the receive shift register, the data portion of the character transfers to the SCDR. The SCI receiver full bit, SCRF, in SCI status register 1 (SCS1) becomes set, indicating that the received byte can be read. If the SCI receive interrupt enable bit, SCRIE, in SCC2 is also set, the SCRF bit generates a receiver CPU interrupt request.



Serial Communications Interface Module (SCI)

To determine the value of a data bit and to detect noise, recovery logic takes samples at RT8, RT9, and RT10. Table 13-3 summarizes the results of the data bit samples.

RT8, RT9, and RT10 Samples	Data Bit Determination	Noise Flag
000	0	0
001	0	1
010	0	1
011	1	1
100	0	1
101	1	1
110	1	1
111	1	0

NOTE

The RT8, RT9, and RT10 samples do not affect start bit verification. If any or all of the RT8, RT9, and RT10 start bit samples are logic 1s following a successful start bit verification, the noise flag (NF) is set and the receiver assumes that the bit is a start bit.

To verify a stop bit and to detect noise, recovery logic takes samples at RT8, RT9, and RT10. Table 13-4 summarizes the results of the stop bit samples.

RT8, RT9, and RT10 Samples	Framing Error Flag	Noise Flag		
000	1	0		
001	1	1		
010	1	1		
011	0	1		
100	1	1		
101	0	1		
110	0	1		
111	0	0		

Table 13-4. Stop Bit Recovery

13.4.3.4 Framing Errors

If the data recovery logic does not detect a logic 1 where the stop bit should be in an incoming character, it sets the framing error bit, FE, in SCS1. A break character also sets the FE bit because a break character has no stop bit. The FE bit is set at the same time that the SCRF bit is set.

13.4.3.5 Baud Rate Tolerance

A transmitting device may be operating at a baud rate below or above the receiver baud rate. Accumulated bit time misalignment can cause one of the three stop bit data samples to fall outside the actual stop bit. Then a noise error occurs. If more than one of the samples is outside the stop bit, a framing



13.7.2 PTE1/RxD (Receive Data)

The PTE1/RxD pin is the serial data input to the SCI receiver. The SCI shares the PTE1/RxD pin with port E. When the SCI is enabled, the PTE1/RxD pin is an input regardless of the state of the DDRE1 bit in data direction register E (DDRE).

13.8 I/O Registers

These I/O registers control and monitor SCI operation:

- SCI control register 1 (SCC1)
- SCI control register 2 (SCC2)
- SCI control register 3 (SCC3)
- SCI status register 1 (SCS1)
- SCI status register 2 (SCS2)
- SCI data register (SCDR)
- SCI baud rate register (SCBR)

13.8.1 SCI Control Register 1

SCI control register 1:

- Enables loop mode operation
- Enables the SCI
- Controls output polarity
- Controls character length
- Controls SCI wakeup method
- Controls idle character detection
- Enables parity function
- Controls parity type

Address: \$0013

	Bit 7	6	5	4	3	2	1	Bit 0
Read: Write:	LOOPS	ENSCI	TXINV	М	WAKE	ILTY	PEN	PTY
Reset:	0	0	0	0	0	0	0	0

Figure 13-9. SCI Control Register 1 (SCC1)

LOOPS — Loop Mode Select Bit

This read/write bit enables loop mode operation. In loop mode the PTE1/RxD pin is disconnected from the SCI, and the transmitter output goes into the receiver input. Both the transmitter and the receiver must be enabled to use loop mode. Reset clears the LOOPS bit.

1 = Loop mode enabled

0 = Normal operation enabled

ENSCI — Enable SCI Bit

This read/write bit enables the SCI and the SCI baud rate generator. Clearing ENSCI sets the SCTE and TC bits in SCI status register 1 and disables transmitter interrupts. Reset clears the ENSCI bit.

1 = SCI enabled

0 = SCI disabled



Serial Communications Interface Module (SCI)

TXINV — Transmit Inversion Bit

This read/write bit reverses the polarity of transmitted data. Reset clears the TXINV bit.

- 1 = Transmitter output inverted
- 0 = Transmitter output not inverted

NOTE

Setting the TXINV bit inverts all transmitted values, including idle, break, start, and stop bits.

M — Mode (Character Length) Bit

This read/write bit determines whether SCI characters are eight or nine bits long. (See Table 13-5.) The ninth bit can serve as an extra stop bit, as a receiver wakeup signal, or as a parity bit. Reset clears the M bit.

1 = 9-bit SCI characters

0 = 8-bit SCI characters

WAKE — Wakeup Condition Bit

This read/write bit determines which condition wakes up the SCI: a logic 1 (address mark) in the most significant bit position of a received character or an idle condition on the PTE1/RxD pin. Reset clears the WAKE bit.

1 = Address mark wakeup

0 = Idle line wakeup

ILTY — Idle Line Type Bit

This read/write bit determines when the SCI starts counting logic 1s as idle character bits. The counting begins either after the start bit or after the stop bit. If the count begins after the start bit, then a string of logic 1s preceding the stop bit may cause false recognition of an idle character. Beginning the count after the stop bit avoids false idle character recognition, but requires properly synchronized transmissions. Reset clears the ILTY bit.

1 = Idle character bit count begins after stop bit

0 = Idle character bit count begins after start bit

PEN — Parity Enable Bit

This read/write bit enables the SCI parity function. (See Table 13-5.) When enabled, the parity function inserts a parity bit in the most significant bit position. (See Figure 13-3.) Reset clears the PEN bit.

1 = Parity function enabled

0 = Parity function disabled

PTY — Parity Bit

This read/write bit determines whether the SCI generates and checks for odd parity or even parity. (See Table 13-5.) Reset clears the PTY bit.

1 = Odd parity

0 = Even parity

NOTE

Changing the PTY bit in the middle of a transmission or reception can generate a parity error.



Serial Communications Interface Module (SCI)

13.8.4 SCI Status Register 1

SCI status register 1 (SCS1) contains flags to signal these conditions:

- Transfer of SCDR data to transmit shift register complete
- Transmission complete
- Transfer of receive shift register data to SCDR complete
- Receiver input idle
- Receiver overrun
- Noisy data
- Framing error
- Parity error



Figure 13-12. SCI Status Register 1 (SCS1)

SCTE — SCI Transmitter Empty Bit

This clearable, read-only bit is set when the SCDR transfers a character to the transmit shift register. SCTE can generate an SCI transmitter CPU interrupt request. When the SCTIE bit in SCC2 is set, SCTE generates an SCI transmitter CPU interrupt request. In normal operation, clear the SCTE bit by reading SCS1 with SCTE set and then writing to SCDR. Reset sets the SCTE bit.

1 = SCDR data transferred to transmit shift register

0 = SCDR data not transferred to transmit shift register

TC — Transmission Complete Bit

This read-only bit is set when the SCTE bit is set, and no data, preamble, or break character is being transmitted. TC generates an SCI transmitter CPU interrupt request if the TCIE bit in SCC2 is also set. TC is automatically cleared when data, preamble or break is queued and ready to be sent. There may be up to 1.5 transmitter clocks of latency between queueing data, preamble, and break and the transmission actually starting. Reset sets the TC bit.

- 1 = No transmission in progress
- 0 = Transmission in progress

SCRF — SCI Receiver Full Bit

This clearable, read-only bit is set when the data in the receive shift register transfers to the SCI data register. SCRF can generate an SCI receiver CPU interrupt request. When the SCRIE bit in SCC2 is set, SCRF generates a CPU interrupt request. In normal operation, clear the SCRF bit by reading SCS1 with SCRF set and then reading the SCDR. Reset clears SCRF.

- 1 = Received data available in SCDR
- 0 = Data not available in SCDR

IDLE — Receiver Idle Bit

This clearable, read-only bit is set when 10 or 11 consecutive logic 1s appear on the receiver input. IDLE generates an SCI receiver CPU interrupt request if the ILIE bit in SCC2 is also set. Clear the IDLE bit by reading SCS1 with IDLE set and then reading the SCDR. After the receiver is enabled, it must



System Integration Module (SIM)



Figure 14-1. SIM Block Diagram

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
		Read: Write:	R	R	R	R	R	R	SBSW	R
\$FE00	SIM Break Status Register (SBSR)								Note	
	(020.1)	Reset:		-					0	
	Note: Writing a logic 0 clears	SBSW.								
		Read:	POR	PIN	COP	ILOP	ILAD	MODRST	LVI	0
\$FE01 SIM Reset Status R	SIM Reset Status Register (SRSR)	Write:								
	(0.101.)	POR:	1	0	0	0	0	0	0	0
\$FE02 SI		Read:	B	B	B	B	B	D	B	Р
	SIM Upper Byte Address Register (SUBAR)	Write:	11	11	11		11	11	11	
		Reset:		_						
		(= Unimpleme	ented	R	= Reserved			

Figure 14-2. SIM I/O Register Summary



Timebase Module (TBM)



Figure 16-1. Timebase Block Diagram

16.4 Timebase Register Description

The timebase has one register, the TBCR, which is used to enable the timebase interrupts and set the rate.



Figure 16-2. Timebase Control Register (TBCR)

TBIF — Timebase Interrupt Flag

This read-only flag bit is set when the timebase counter has rolled over.

- 1 = Timebase interrupt pending
- 0 = Timebase interrupt not pending



17.5 Interrupts

The following TIM sources can generate interrupt requests:

- TIM overflow flag (TOF) The TOF bit is set when the TIM counter reaches the modulo value programmed in the TIM counter modulo registers. The TIM overflow interrupt enable bit, TOIE, enables TIM overflow CPU interrupt requests. TOF and TOIE are in the TIM status and control register.
- TIM channel flags (CH1F:CH0F) The CHxF bit is set when an input capture or output compare occurs on channel x. Channel x TIM CPU interrupt requests are controlled by the channel x interrupt enable bit, CHxIE. Channel x TIM CPU interrupt requests are enabled when CHxIE = 1. CHxF and CHxIE are in the TIM channel x status and control register.

17.6 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power- consumption standby modes.

17.6.1 Wait Mode

The TIM remains active after the execution of a WAIT instruction. In wait mode, the TIM registers are not accessible by the CPU. Any enabled CPU interrupt request from the TIM can bring the MCU out of wait mode.

If TIM functions are not required during wait mode, reduce power consumption by stopping the TIM before executing the WAIT instruction.

17.6.2 Stop Mode

The TIM is inactive after the execution of a STOP instruction. The STOP instruction does not affect register conditions or the state of the TIM counter. TIM operation resumes when the MCU exits stop mode after an external interrupt.

17.7 TIM During Break Interrupts

A break interrupt stops the TIM counter.

The system integration module (SIM) controls whether status bits in other modules can be cleared during the break state. The BCFE bit in the SIM break flag control register (SBFCR) enables software to clear status bits during the break state. See 14.7.3 SIM Break Flag Control Register.

To allow software to clear status bits during a break interrupt, write a logic 1 to the BCFE bit. If a status bit is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect status bits during the break state, write a logic 0 to the BCFE bit. With BCFE at logic 0 (its default state), software can read and write I/O registers during the break state without affecting status bits. Some status bits have a 2-step read/write clearing procedure. If software does the first step on such a bit before the break, the bit cannot change during the break state as long as BCFE is at logic 0. After the break, doing the second step clears the status bit.



Electrical Specifications

Characteristic ⁽¹⁾	Symbol	Min	Typ ⁽²⁾	Мах	Unit
Pullup resistors (as input only) Ports PTA7/KBD7–PTA0/KBD0, PTC6–PTC0, PTD7/T2CH1–PTD0/SS	R _{PU}	20	45	65	kΩ
Capacitance Ports (as input or output)	C _{Out} C _{In}			12 8	pF
Monitor mode entry voltage	V _{TST}	V _{DD} + 2.5	_	9	V
Low-voltage inhibit, trip falling voltage	V _{TRIPF}	2.45	2.60	2.70	V
Low-voltage inhibit, trip rising voltage	V _{TRIPR}	2.55	2.66	2.80	V
Low-voltage inhibit reset/recover hysteresis (V _{TRIPF} + V _{HYS} = V _{TRIPR})	V _{HYS}	_	60	_	mV
POR rearm voltage ⁽¹²⁾	V _{POR}	0		100	mV
POR reset voltage ⁽¹³⁾	V _{PORRST}	0	700	800	mV
POR rise time ramp rate ⁽¹⁴⁾	R _{POR}	0.02			V/ms

Notes:

1. V_{DD} = 3.0 Vdc \pm 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H, unless otherwise noted 2. Typical values reflect average measurements at midpoint of voltage range, 25 °C only.

3. Run (operating) I_{DD} measured using external square wave clock source (f_{OSC} = 16.4 MHz). All inputs 0.2V from rail. No dc loads. Less than 100 pF on all outputs. CL = 20 pF on OSC2. All ports configured as inputs. OSC2 capacitance linearly affects run IDD. Measured with all modules enabled.

4. Wait I_{DD} measured using external square wave clock source (f_{OSC} = 16.4 MHz). All inputs 0.2 V from rail. No dc loads. Less than 100 pF on all outputs. C₁ = 20 pF on OSC2. All ports configured as inputs. OSC2 capacitance linearly affects wait I_{DD} . Measured with PLL and $L\overline{VI}$ enabled.

5. Stop I_{DD} is measured with OSC1 = V_{SS}.

6. Stop IDD with TBM enabled is measured using an external square wave clock source (fOSC = 16.4 MHz). All inputs 0.2V from rail. No dc loads. Less than 100 pF on all outputs. All inputs configured as inputs.

7. This parameter is characterized and not tested on each device.

8. All functional non-supply pins are internally clamped to V_{SS} and V_{DD} .

9. Input must be current limited to the value specified. To determine the value of the required current-limiting resistor, calculate resistance values for positive and negative clamp voltages, then use the larger of the two values.

10. Power supply must maintain regulation within operating V_{DD} range during instantaneous and operating maximum current conditions. If positive injection current (Vin > VDD) is greater than IDD, the injection current may flow out of VDD and could result in external power supply going out of regulation. Ensure external V_{DD} load will shunt current greater than maximum injection current. This will be the greatest risk when the MCU is not consuming power. Examples are: if no system clock is present, or if clock rate is very low (which would reduce overall power consumption).

11. Pullups and pulldowns are disabled.

12. Maximum is highest voltage that POR is guaranteed.

13. Maximum is highest voltage that POR is possible.

14. If minimum V_{DD} is not reached before the internal POR reset is released, RST must be driven low externally until minimum V_{DD} is reached.



Electrical Specifications

19.8 3.0-V Control Timing

Characteristic ⁽¹⁾	Symbol	Min	Max	Unit
Frequency of operation	face	20	100	kU-7
External clock option ⁽²⁾	OSC	dc	16.4	MHz
Internal operating frequency	f _{OP} (f _{BUS})	—	4.1	MHz
Internal clock period (1/f _{OP})	t _{CYC}	244	—	ns
RST input pulse width low	t _{IRL}	200	—	ns
IRQ interrupt pulse width low (edge-triggered)	t _{ILIH}	200	_	ns
IRQ interrupt pulse period	t _{ILIL}	(3)	_	t _{CYC}

Notes:

1. $V_{SS} = 0$ Vdc; timing shown with respect to 20% V_{DD} and 70% V_{DD} unless otherwise noted. 2. No more than 10% duty cycle deviation from 50% 3. The minimum period, t_{ILIL} or t_{TLTL} , should not be less than the number of cycles it takes to execute the interrupt service routine plus t_{CYC}.



Figure 19-1. RST and IRQ Timing



Electrical Specifications

19.14 3.0-V SPI Characteristics

Diagram Number ⁽¹⁾	Characteristic ⁽²⁾	Symbol	Min	Мах	Unit
	Operating frequency Master Slave	f _{OP(M)} f _{OP(S)}	f _{OP} /128 dc	f _{OP} /2 f _{OP}	MHz MHz
1	Cycle time Master Slave	t _{CYC(M)} t _{CYC(S)}	2 1	128 —	t _{CYC} t _{CYC}
2	Enable lead time	t _{Lead(s)}	1	—	t _{CYC}
3	Enable lag time	t _{Lag(s)}	1	—	t _{CYC}
4	Clock (SPSCK) high time Master Slave	t _{SCKH(M)} t _{SCKH(S)}	t _{CYC} −35 1/2 t _{CYC} −35	64 t _{CYC}	ns ns
5	Clock (SPSCK) low time Master Slave	t _{SCKL(M)} t _{SCKL(S)}	t _{CYC} –35 1/2 t _{CYC} –35	64 t _{CYC} —	ns ns
6	Data setup time (inputs) Master Slave	t _{SU(M)} t _{SU(S)}	40 40		ns ns
7	Data hold time (inputs) Master Slave	t _{H(M)} t _{H(S)}	40 40		ns ns
8	Access time, slave ⁽³⁾ CPHA = 0 CPHA = 1	t _{A(CP0)} t _{A(CP1)}	0 0	50 50	ns ns
9	Disable time, slave ⁽⁴⁾	t _{DIS(S)}	_	50	ns
10	Data valid time, after enable edge Master Slave ⁽⁵⁾	t _{V(M)} t _{V(S)}		60 60	ns ns
11	Data hold time, outputs, after enable edge Master Slave	t _{HO(M)} t _{HO(S)}	0 0	_ _	ns ns

Notes:

1. Numbers refer to dimensions in Figure 19-17 and Figure 19-18. 2. All timing is shown with respect to 20% V_{DD} and 70% V_{DD} , unless noted; 100 pF load on all SPI pins. 3. Time to data active from high-impedance state

4. Hold time to high-impedance state5. With 100 pF on all SPI pins